

MEDIA NEWS RELEASE

Leader Tech Contact:

Tim Black, Director- Business Development

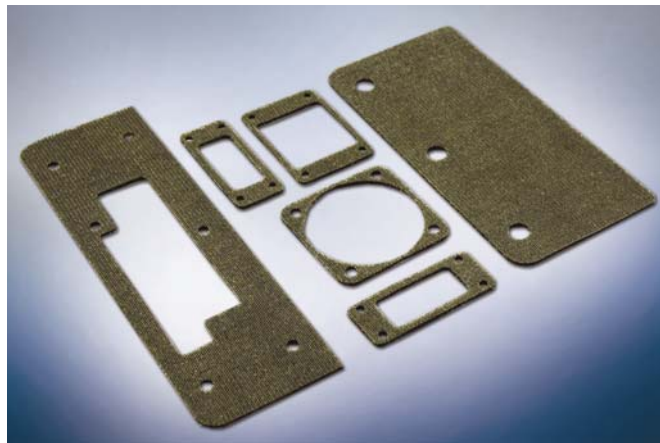
E-mail: tblack@leadertechinc.com Phone: 813-855-6921

Low Compression Conductive Foam

Tampa, FL —Wednesday, May 11, 2011—A new EMI shielding material from Leader Tech significantly improves the quality and performance of die-cut enclosure gaskets.

The Company's low compression CFS Conductive Foam Shielding material is manufactured in sheets that have a low-resistance polyester fabric surface and a resilient Nickel-Copper polyurethane foam center. These characteristics make CFS the ideal choice for intricate die-cut finishing operations found in many I/O panel, backplane and access panel applications. A standard conductive, pressure sensitive adhesive facilitates fast and easy installation.

Leader Tech's CFS gaskets offer a typical Shielding Effectiveness of 60dB between 10MHz-3GHz. In addition, the conductive foam exhibits a compression load of 2.1 psi at 30% compression and has an operational temperature range from -40°F to +156°F.



About Leader Tech

Leader Tech is a world-leading innovator and manufacturer of EMI shielding products for circuit boards, electronic enclosures and interconnect cables. The company's core product offerings include standard and custom circuit board shields, beryllium copper fingerstock gaskets, conductive elastomers, advanced RF absorber materials and EMI/RFI ferrites. Leader Tech is a wholly owned subsidiary of HEICO Corporation, a successful and growing technology-driven aerospace, defense and electronics company. HEICO Corporation is a New York Stock Exchange listed company (NYSE: HEI and HEIA) and has been ranked as one of the 200 "Best Small Companies" and 200 "Hot Shot Stocks" by Forbes. For more information, call (813) 855-6921 or visit us on the Web at <http://www.leadertechinc.com>.